

1.Description

RailClamp is an ultra low capacitance Transient Voltage Suppressor (TVS) designed to protect high speed data interfaces. This device has been specifically designed to protect sensitive components which are connected to highspeed data and transmission lines from over-voltage caused by ESD (electrostatic discharge), CDE (Cable Discharge Events), and EFT (electrical fast transients).

3.Features

- Transient protection for data lines to
- IEC 61000-4-2 (ESD) $\pm 20\text{kV}$ (air), $\pm 12\text{kV}$ (contact)
- IEC 61000-4-4 (EFT) 40A ($t_p = 5/50\text{ns}$)
- Cable Discharge Event (CDE)
- Ultra-small package (1.0 x 0.6 x 0.4mm)

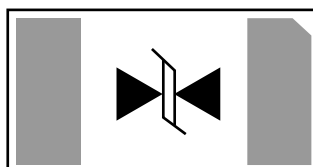
4.Mechanical Characteristics

- SLP1006P2T package
- Molding compound flammability rating: UL 94V-0
- Marking: Marking code + date code

2.Applications

- Cellular Handsets & Accessories
- Digital Visual Interface (DVI)
- FM Antenna
- MDDI Ports
- USB Ports
- PCI Express
- Serial ATA
- Protects one I/O line
- Low capacitance: 0.8pF
- Low clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

5.Pinning information



SLP1006P2



6. Absolute Maximum Rating

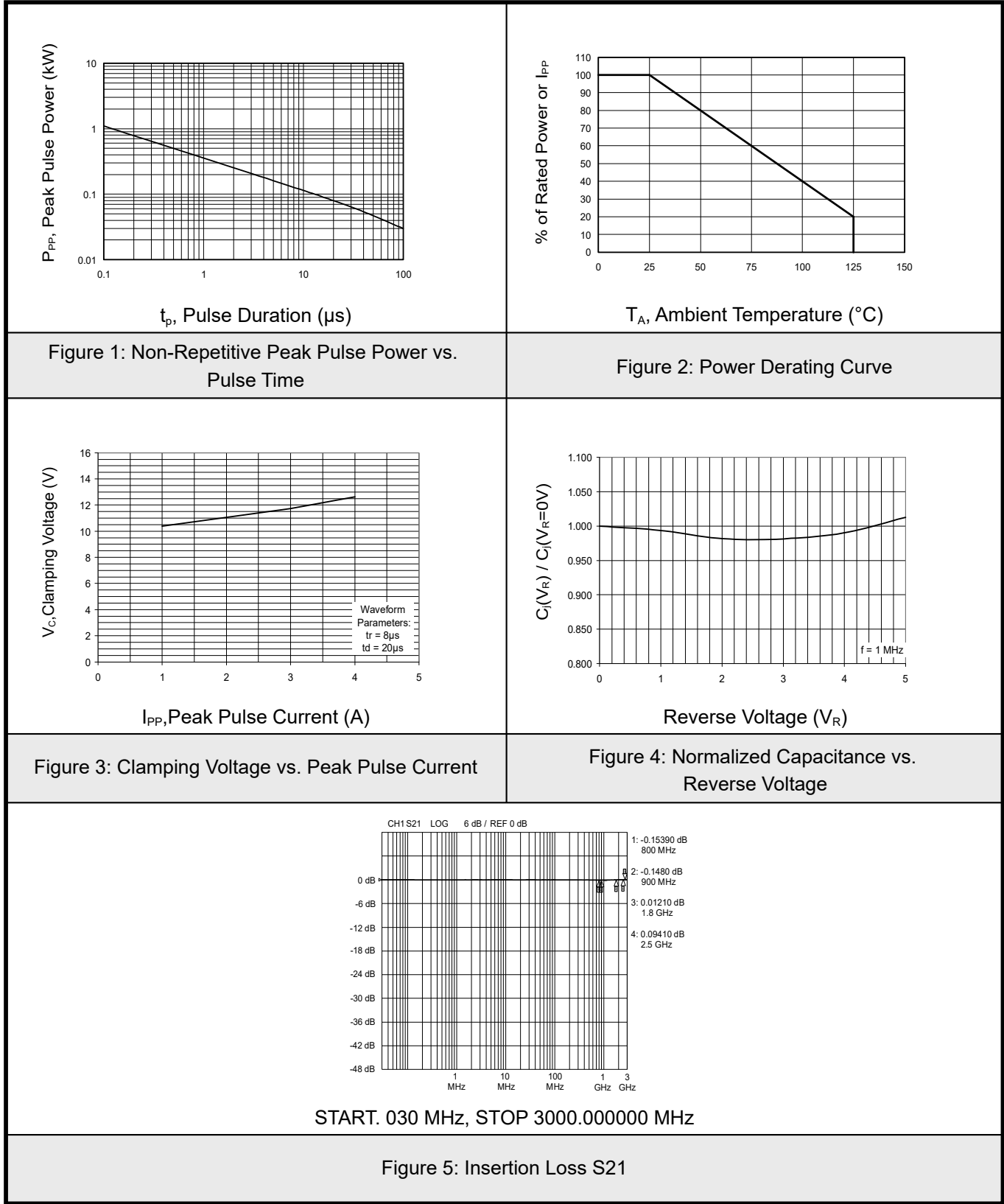
Parameter	Symbol	Value	Units
Peak Pulse Power ($t_p=8/20\mu s$)	P_{PK}	80	W
Peak Pulse Current ($t_p=8/20\mu s$)	I_{PP}	4	A
ESD per IEC 61000-4-2(Air)	V_{ESD}	± 20	kV
ESD per IEC 61000-4-2(Contact)		± 12	kV
Junction Temperature Range	T_J	-55 to 125	$^{\circ}C$
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}C$

7. Electrical Characteristics ($T_A=25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Reverse Stand-Off Voltage	V_{RWM}				5	V
Reverse Breakdown Voltage	V_{BR}	$I_T=1mA$	6	9.3	11	V
Reverse Leakage Current	I_R	$V_{RWM}=5V, T=25^{\circ}C$		0.01	0.1	μA
Clamping Voltage	V_C	$I_{PP}=1A (t_p=8/20\mu s)$			12	V
		$I_{PP}=4A (t_p=8/20\mu s)$			20	V
Junction Capacitance	C_J	$V_R=0V, f=1MHz$		0.5	0.8	pF



8.1Typical characteristic



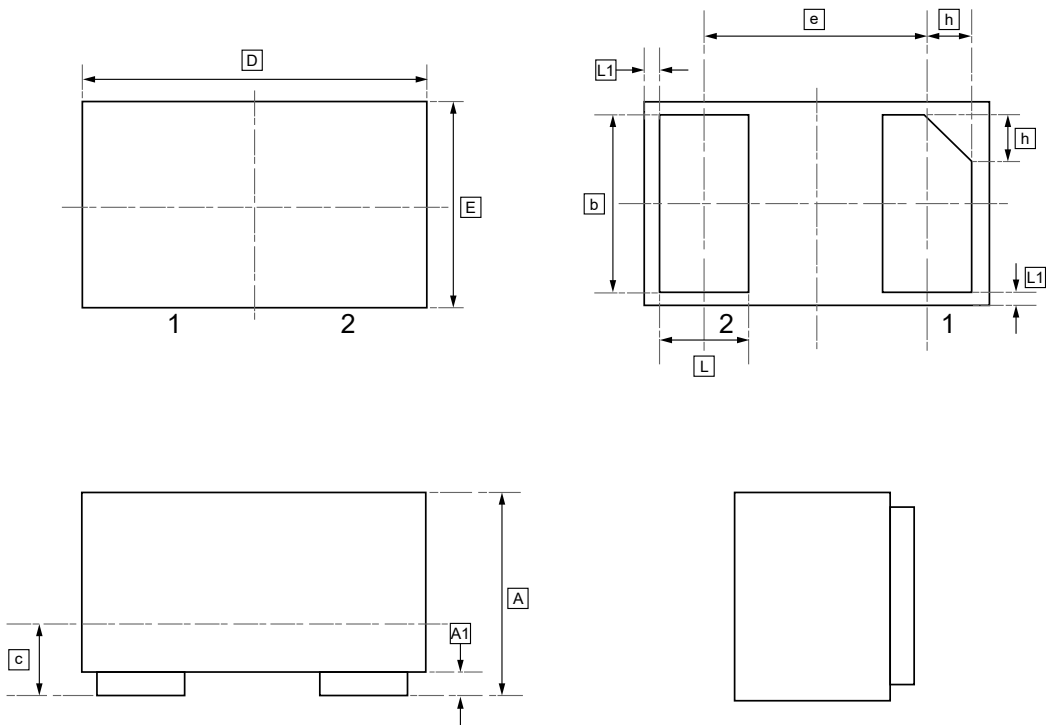


8.2Typical characteristic

Tek Run: 5.00GS/s Sample 100% Note: Data is taken with a 10x attenuator Figure 6: ESD Clamping (+8kV Contact per IEC 61000-4-2)	Tek Run: 5.00GS/s Sample 100% Note: Data is taken with a 10x attenuator Figure 7: ESD Clamping (-8kV Contact per IEC 61000-4-2)
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9.SLP1006P2 Package Outline Dimensions

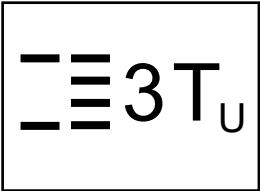


DIMENSIONS (mm are the original dimensions)

Symbol	A	A1	b	c	D	e	E	L	L1	h
Min	0.45	0.00	0.45	0.12	0.95	0.65	0.55	0.20	0.05	0.07
Max	0.55	0.05	0.55	0.18	1.05	BSC	0.65	0.30	REF	0.17



10.Ordering information



Order Code	Package	Base QTY	Delivery Mode
UMW RCLAMP0531T.TCT	SLP1006P2	3000	Tape and reel



11.Disclaimer

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